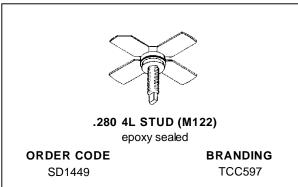


SD1449 (TCC597)

RF & MICROWAVE TRANSISTORS UHF TV\LINEAR APPLICATIONS

- 860 MHz
- 20 VOLTS
- COMMON EMITTER
- GOLD METALLIZATION
- CLASS A LINEAR OPERATION
- Pout = 1.0 W MIN. WITH 10.0 dB GAIN



DESCRIPTION

The SD1449 is a silicon NPN bipolar device specifically designed for high linearity applications in the UHF frequency range including TV Bands IV and V.

Gold metallization and emitter ballasting assure high reliability under Class A linear amplifier operation.

PIN CONNECTION 1. Collector 3. Base 2. Emitter 4. Emitter

ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit	
Vсво	Collector-Base Voltage 45			
V _{CEO}	Collector-Emitter Voltage	25	V	
V _{EBO}	Emitter-Base Voltage 3.5		V	
Ic	Device Current	1.2	А	
Poiss	Power Dissipation	19.4	W	
TJ	Junction Temperature	+200	°C	
T _{STG}	Storage Temperature	– 65 to +150	°C	

THERMAL DATA

R _{TH(j-c)} Junction-Case Thermal Resistance	9.0	°C/W
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July 27, 1994 1/4

SD1449 (TCC597)

ELECTRICAL SPECIFICATIONS (Tcase = 25°C)

STATIC

Symbol	Test Conditions	Value			Unit		
Symbol		rest conditions		Min.	Тур.	Max.	Oiiit
ВУсво	I _C = 2 mA	$I_E = 0 \text{ mA}$		45	_	_	V
BVCER	I _C = 40 mA	$R_{BE} = 10 \Omega$		50	_		V
BV _{CEO}	I _C = 40 mA	$I_B = 0 \text{ mA}$		24	_	_	V
BV _{EBO}	I _E = .5 mA	$I_C = 0 \text{ mA}$		3.5	_	_	V
I _{CBO}	V _{CB} = 28 V	I _E = 0 mA		_	_	0.45	mA
hFE	Vce = 5 V	$I_C = 200 \text{ mA}$		20	_	120	_

DYNAMIC

Symbol	mbol Test Conditions			Value			Unit
Symbol				Min.	Тур.	Max.	Unit
Pour ¹	f = 860 MHz	$V_{CE} = 20 V$	$I_C = 440 \text{ mA}$	1	_	_	W
P _G ²	f = 860 MHz	V _{CE} = 20 V	$I_C = 440 \text{ mA}$	10	_	_	dB
IMD ₃ ³	P _{SYNC} = 1 W	V _{CE} = 20 V	I _C = 440 mA	_	_	-58	dBc
IMD ₃ ³	Psync = 2 W	V _{CE} = 20 V	I _C = 440 mA	_	_	-51	dBc
Сов	f = 1 MHzV _{CB} = 20V			_	_	7	pF

Note 1: $P_{IN} = 0.1W$

Note 2: $P_{OUT} = 1 W$

Note 3: Levels relative to PSYNC

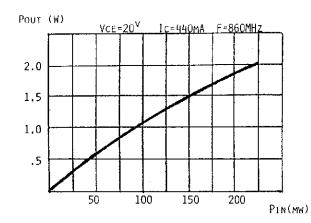
 $f_1 = 860.0 \text{ MHz} -8 \text{dBc}$

 $f_2 = 863.5 \text{ MHz} -16 \text{dBc}$

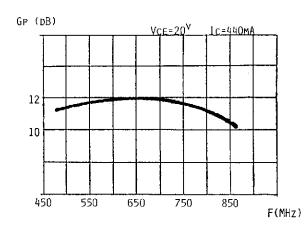
 $f_3 = 864.5 \text{ MHz} -7 \text{dBc}$

TYPICAL PERFORMANCE

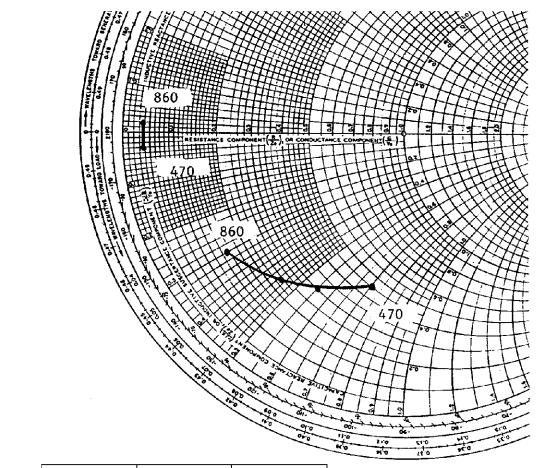
POWER OUTPUT vs INPUT POWER



BROADBAND POWER GAIN vs FREQUENCY



IMPEDANCE DATA

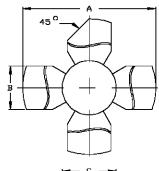


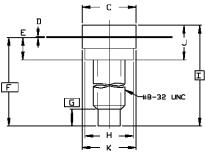
FREQ.	Z _{IN} (Ω)	Ζουτ (Ω)
860 MHz	1.8 + j 0.8	8.0 – j 15.0
650 MHz	1.9 – j 0.5	15.0 – j 27.0
470 MHz	2.0 – j 1.5	23.0 – j 35.0

 $V_{CC} = 20 \text{ V}$ $I_C = 440 \text{ mA}$

PACKAGE MECHANICAL DATA

Ref.: Dwg. No.12-0122 rev. B





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	MINIMUM	MAXIMUM			
	Inches/mm	Inches/mm			
Α	1.010/25,65 1.055/26,8				
В	.220/5,59 .230/5,84				
С	.270/6,86 .285/7,24				
D	.003/0,08 .007/0,1				
Ε	.117/2,97 .137/3,48				
F	.572/14,53				
G	.130/3,30				
Н	.245/6,22 .255/6,48				
I	.640/16,26				
J	.175/4,45	.217/5,51			
К	.275/6,99 .285/7,24				

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